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Customer No. 30425

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: : Henry Michael Siegel, et al.

For : SYSTEM AND METHOD FOR USING A PRE-FORMED FILM
IN A TRANSFER MOLDING PROCESS FOR AN
INTEGRATED CIRCUIT

BOX PATENT APPLICATION

Commissioner for Patents
Washington, D. C. 20231

Sir:

ATTORNEY CORRESPONDENCE ADDRESS

Please direct future correspondence and telephone calls relating to this patent application to the
following:

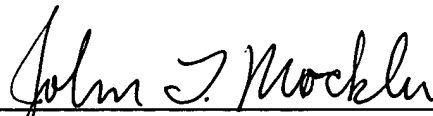
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Respectfully submitted,

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Date: 31 January 2002



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